Soft Recovery Diode M0433WC120 to M0433WC200

The data sheet on the subsequent pages of this document is a scanned copy of existing data for this product.

(Rating Report 80NR14 Issue 2)

This data reflects the old part number for this product which is: SM12-20CXC174. This part number must NOT be used for ordering purposes – please use the ordering particulars detailed below.

The limitations of this data are as follows: This device is available for grades 12 to 20 (1200V to 2000V V_{RRM})

Please use the following link to view an up to date outline drawing for this device Outline W1

Where any information on the product matrix page differs from that in the following data, the product matrix must be considered correct

An electronic data sheet for this product is presently in preparation.

For further information on this product, please contact your local ASM or distributor.

Alternatively, please contact Westcode as detailed below.

Ordering Particulars			
M0433	WC	**	0
Fixed Type Code	Fixed Outline Code	Voltage code V _{DRM} /100 12-20	Fixed Code
Typical Order Code: M0433WC120, 14mm clamp height, 1200V V _{RRM}			

IXYS Semiconductor GmbH

Edisonstraße 15 D-68623 Lampertheim Tel: +49 6206 503-0 Fax: +49 6206 503-627 E-mail: marcom@ixys.de

IXYS Corporation

3540 Bassett Street Santa Clara CA 95054 USA Tel: +1 (408) 982 0700 Fax: +1 (408) 496 0670 E-mail: sales@ixys.net MESTGODE An EXYS Company

www.westcode.com

www.ixys.com

Westcode Semiconductors Ltd

Langley Park Way, Langley Park, Chippenham, Wiltshire, SN15 1GE. Tel: +44 (0)1249 444524 Fax: +44 (0)1249 659448 E-mail: WSL.sales@westcode.com

Westcode Semiconductors Inc

3270 Cherry Avenue Long Beach CA 90807 USA Tel: +1 (562) 595 6971 Fax: +1 (562) 595 8182 E-mail: <u>WSI.sales@westcode.com</u>

The information contained herein is confidential and is protected by Copyright. The information may not be used or disclosed except with the written permission of and in the manner permitted by the proprietors Westcode Semiconductors Ltd.

© Westcode Semiconductors Ltd.

In the interest of product improvement, Westcode reserves the right to change specifications at any time without prior notice

Devices with a suffix code (2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and limits contained in this report.

QUALITY EVALUATION LABORATORY

Rating Report: 80NR14(Issue 2)

Date: 25th February, 1986

Origin:

Pages:

22

Diode Type SM12-18CXC174

Written	by: M	(W.	Junle P
---------	-------	-----	---------

Checked: M(W)

Approved:

This diode consists of a diffused, fast recovery 24 mm diameter silicon slice mounted in a cold weld capsule housing.

This report supersedes Rating Report No. 80NR14.

Ratings

Ratings	
Voltage Grades	: 12 -1 8
V _{RSM}	: 1300-1900V
V _{RRM}	: 1200-1800V
I _{F(AV)} : Single phase; 50 Hz, 180° half sinewave; (Converter Ratings) Double Side Cooled THS = 55°C, 100°C	: 434A; 202A
Single Side Cooled ^T HS = 100°C	: 114A
$I_{\text{F(rms)}}$ THS = 25°C)	: 870A
I_F $T_{HS} = 25^{\circ}C$) Double side cooled	: 724A
I_{ESM} : t = 10ms half sinewave; T_J (initial) = 125°C; V_{RM} = 0.6 V_{RRM} (Maximum)	AX) 1 4500A
I_{FSM} : t = 10ms half sinewave; T_J (initial) = 125°C; V_{RM} 10V	: 4950A
I^2 t : t = 10ms; T_J (initial = 125°C ; $V_{RM} = 0.6V_{RRM}$ (MAX)	:1.01 x $10^5 A^2 S$
I^2t : t = 10ms; T_J (initial) = 125°C; V_{RM} 10V	$:1.22 \times 10^5 \text{A}^2 \text{S}$
I^2 t : t = 3ms; T_J (initial = 125°C; V_{RM} 10V	$: 0.91 \times 10^5 \text{A}^2$
T _{HS} Operating Ramge	: 40 to +125°C
T _{stg} ; Non-operating	∸ 40 to +150°C

<u>Characteristics</u>

(Maximum values unless stated otherwise)

$V_0 : T_J = 125$ °C	: 1.0V
$r_s : T_J = 125 \circ C$: 0.74mohm
$V_{FM} : I_{FM} = 635A T_{VJ} = 125 ^{\circ}C$: 1.47V
R _{th} (J - H5) Double side cooled	: 0.09°C/W
Single side cooled	:0.18°C/W
$I_{RRM} : T_J = 125 ° C V_{RM} = V_{RRM(MAX)}$: 20mA
Q_{rr} : $I_{FM} = 550A$; $dI/dt = 40A/uS$ (50% chord value)	:
$V_{RM} = 50V$ $T_{VJ} = 125 ^{\circ}C$:160uC
t _{rr} (conditions as above)	:
Mounting Force	: 330-550Kg.f
Outline Drawing	: 100A241
JEDEC NO.	: DO-200AA

CONTENTS

	Page
Ratings and Characteristics	1, 2
Voltage Grade Table	4
(2) <u>Introduction</u>	5
(3) <u>Notes on the Ratings</u>	
(a) Square-wave ratings	5
(b) Energy per pulse characteristics	5
(4) Reverse Recovery Loss	
(a) Determination by Measurement	5
(b) Design Method	6
Limit Forward Characteristic	7
Transient Thermal Impedance	8
Surge Rating	9
Recovered Charge	10
5. Factor	11
Reverse recovery energy per pulse	12
Square wave frequency rating 85°C Sink 200A/uS	13
Square wave frequency rating 55°C Sink 200A/uS	14
Square wave frequency rating 85°C Sink 100A/uS	15
Square wave frequency rating 55 ⁰ C Sink 100A/uS	16
Energy per pulse 200A/uS	17
Energy per pulse 100A/uS	18
Sine wave frequency rating 85 ⁰ C Sink	19
Sine wave frequency rating 55 ⁰ C Sin k	20
Sine wave energy per pulse	21
Outline drawing	22

<u>Voltage Ratings</u>

Voltage Class	V _{RRM} V	V _{RSM} V
12	1200	1300
14	1400	1500
16	1600	1700
18	1800	1900
•		

This Report is applicable to higher or lower voltage grades when supply has been agreed by Sales/Production.

2.0 INTRODUCTION

The diode series comprises fast recovery cold-weld capsules with all diffused silicon slices. All these diodes have controlled reverse recovery characteristics with good "S" factors.

3.0 NOTES ON THE RATINGS

(a) Square wave ratings

These ratings are given for leading edge linear rates of rise of forward current of 200 $\,$ and $\,$ 100A/uS

(b) Energy per pulse characteristics

These curves enable rapid estimation of device dissipation to be obtained for conditions not covered by the frequency ratings.

Let: Ep be the Energy per pulse for a given current and pulse width, in joules.

Then
$$W_{AV} = Ep \times f$$
.

and
$$T_{SINK} = T_{J(MAX)} - W_{AV} R_{th}$$

4.0 REVERSE RECOVERY LOSS

On account of the number of circuit variables affecting reverse recovery voltage, no allowance for reverse recovery loss has been made in these ratings. The following procedure is recommended for use where it is necessary to include reverse recovery loss.

(a) Determination by Measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be A joules per pulse. A new heat sink temperature can then be evaluated from:

$$T_{SINK}$$
 (new) = T_{SINK} (original) - A ($\frac{r_{t}.10^{6}}{t}$ + $R_{th} \times f$)
where r_{t} = 1.64 x 10⁻⁴ \sqrt{t}

t = duration of reverse recovery loss per pulse in microseconds

A = Area under reverse loss waveform per pulse in joules (W.S.)

f = rated frequency at the original heat sink temperature

The total dissipation is now given by

$$W$$
(TOT) = W (original) + $\Lambda \times f$

NOTE 1

REVERSE RECOVERY LOSS BY MEASUREMENT

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge care must be taken to ensure that:

- (a) a.c. coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.
- (b) The measuring oscilloscope has adequate dynamic range typically 100 screen heights - to cope with the initial forward current without overload.
- (c) Measurement of reverse recovery voltage waveform should be carried out with an appropriate snubber of 0.1uF and 5 ohms in series connected across diode anode to cathode.

(b) Design Method

In circumstances where it is not possible to measure voltage and current conditions, or for design purposes, the additional losses may be estimated from curves on page

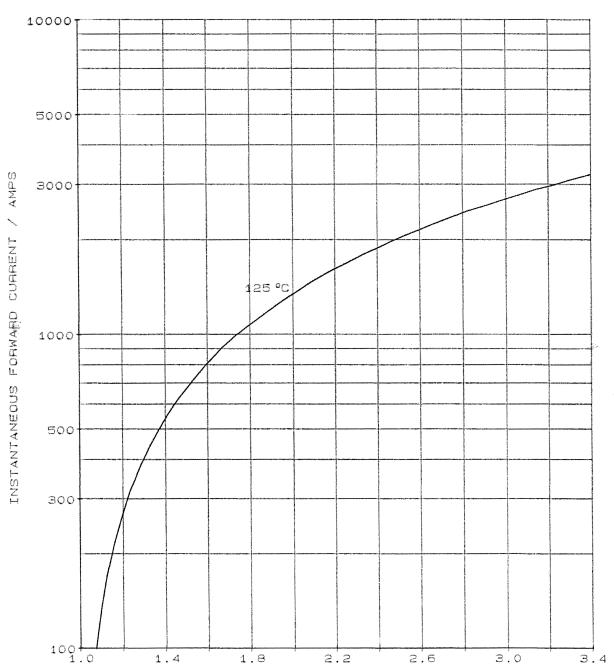
Let E be the value of energy per reverse cycle in joules (curves on page $_{12}$)

Let f be the operating frequency in Hz

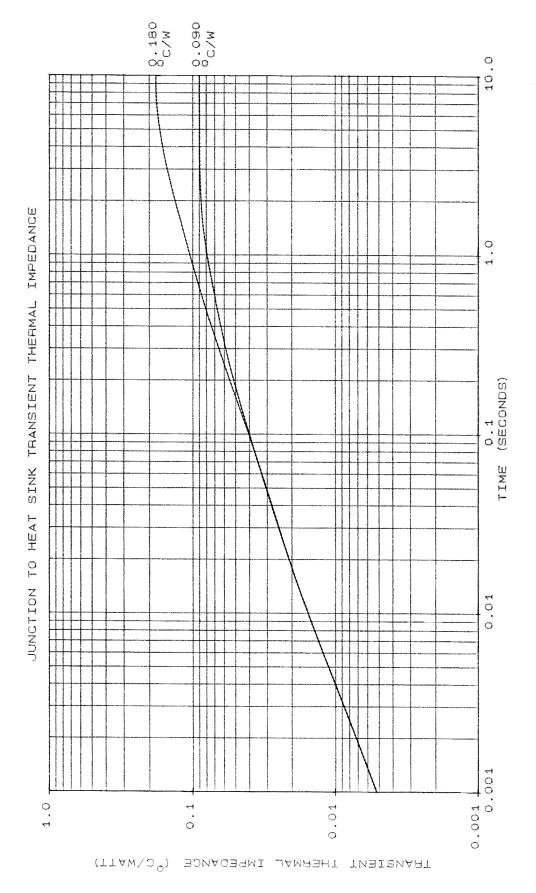
Then
$$T_{SINK}^{(new)} = T_{SINK}^{(original)} - E \times R_{th} \times f$$

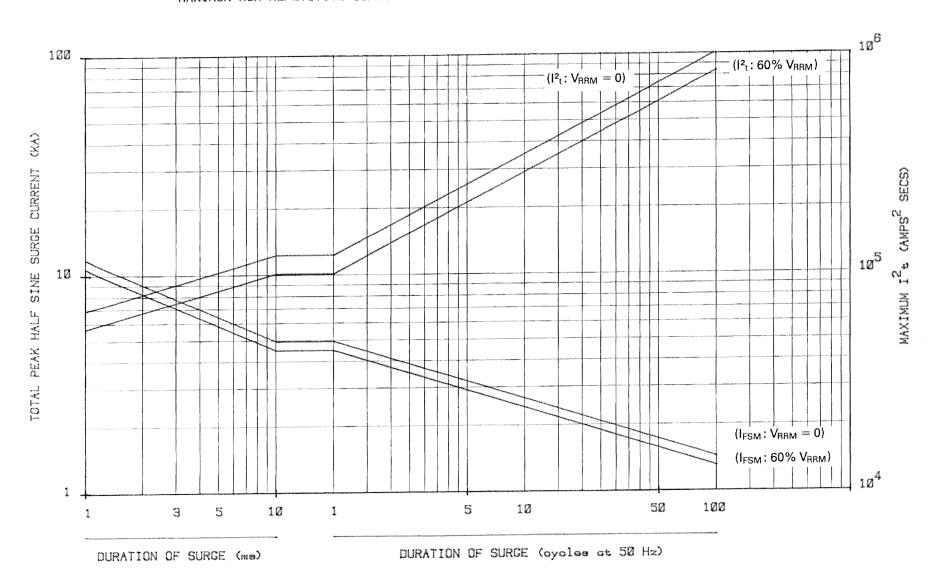
Where $T_{\sf SINK}$ new is the required maximum heat sink temperature and $T_{\sf SINK}$ original is the heat sink temperature given with the frequency ratings.

FORWARD CHARACTERISTIC OF LIMIT DEVICE



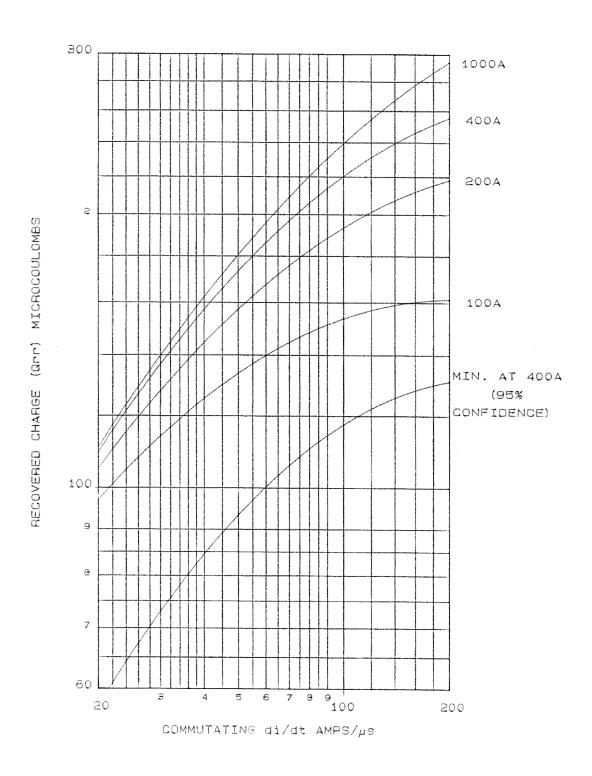
MAXIMUM INSTANTANEOUS FORWARD VOLTAGE / VOLTS



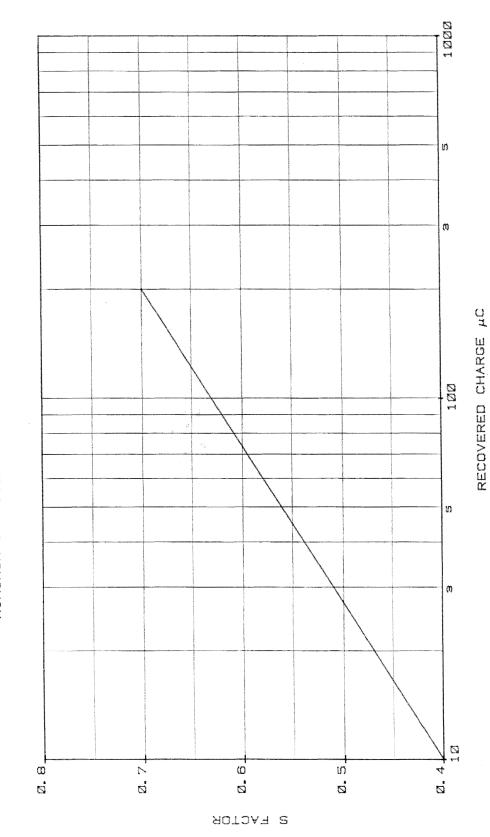


Ç

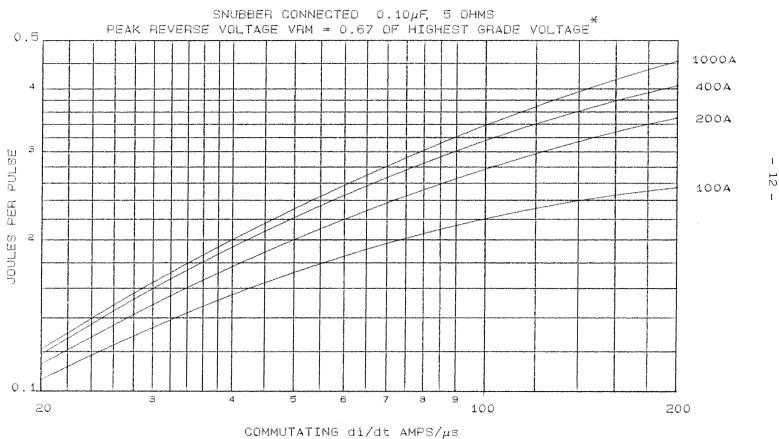
MAXIMUM RECOVERED CHARGE AT 125°C JUNCTION TEMPERATURE



MINIMUM S FACTOR AT 125°C JUNCTION TEMPERATURE

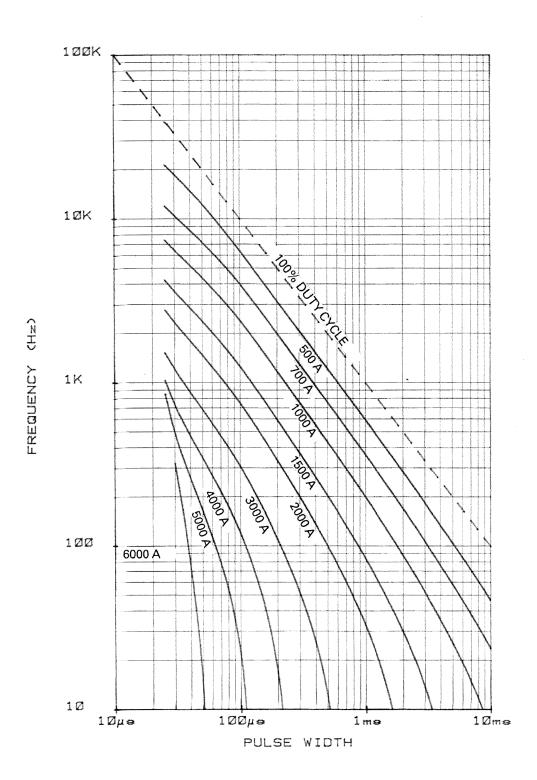


MAXIMUM REVERSE RECOVERY ENERGY LOSS PER PULSE, 1250 JUNCTION TEMPERATURE

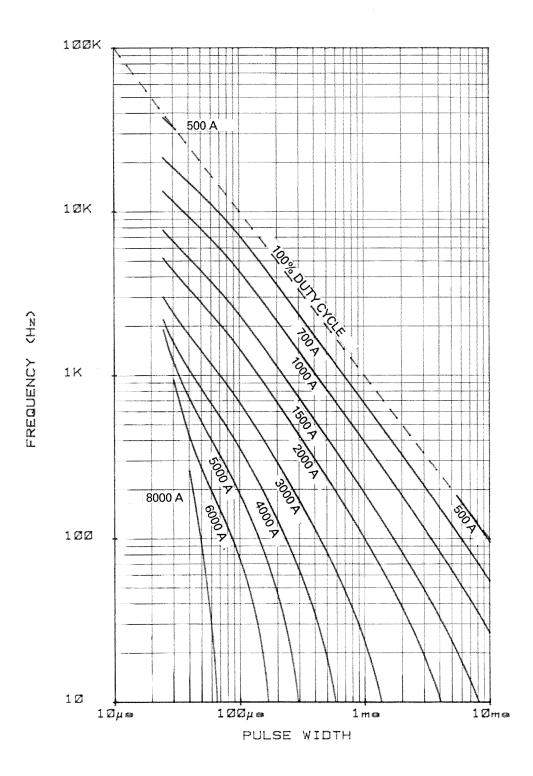


* NOTE: ENERGY PER PULSE SHOULD BE ADJUSTED PRO RATA WITH APPLIED PEAK RECOVERY VOLTAGE

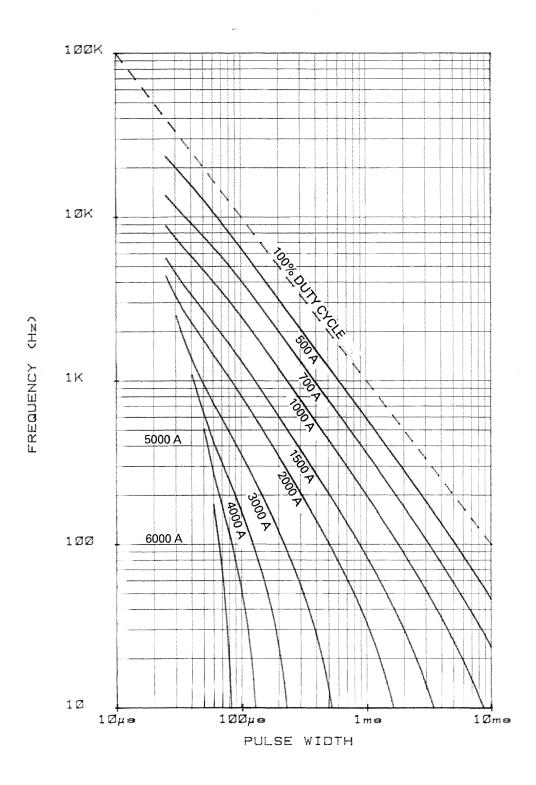
T SINK 85°C. 200A/μο



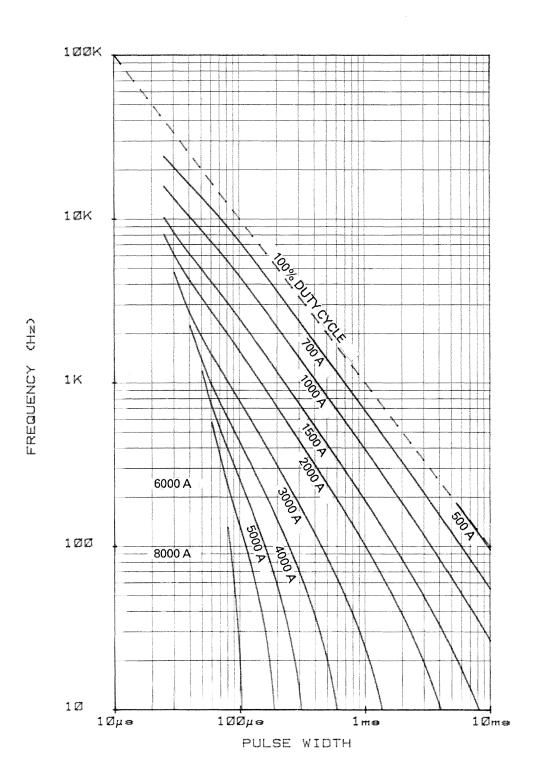
T SINK 55°C. 200λ/μο



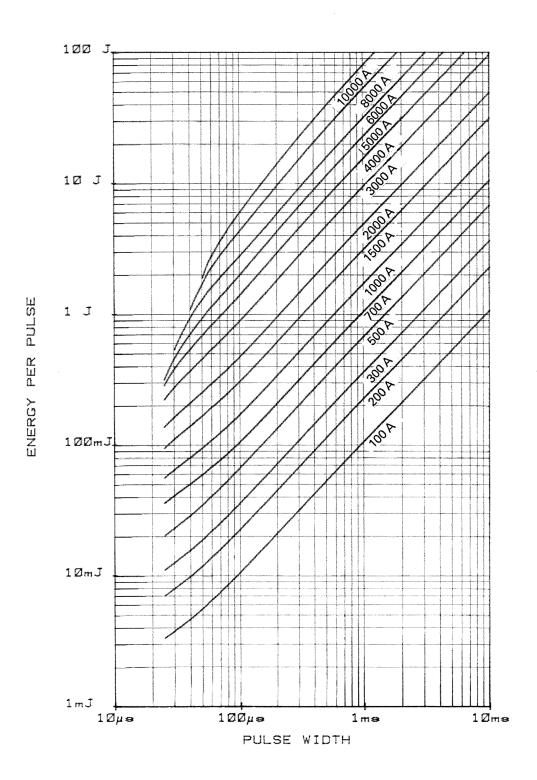
T SINK 85°C. 100A/μ=



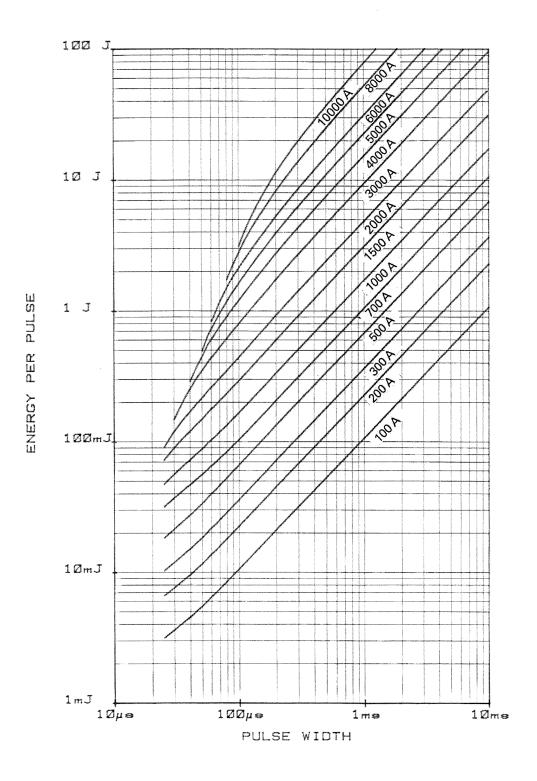
T SINK 55°C. 100A/μο



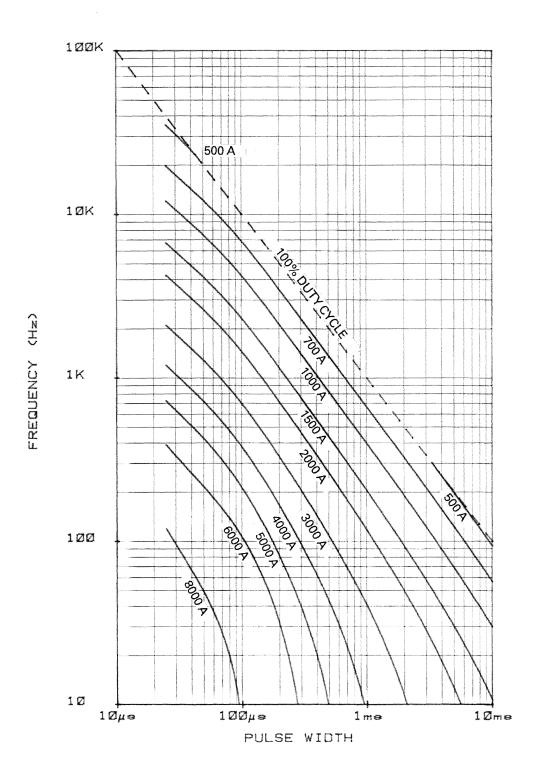
Tj 125°C. 200λ/μ⇔



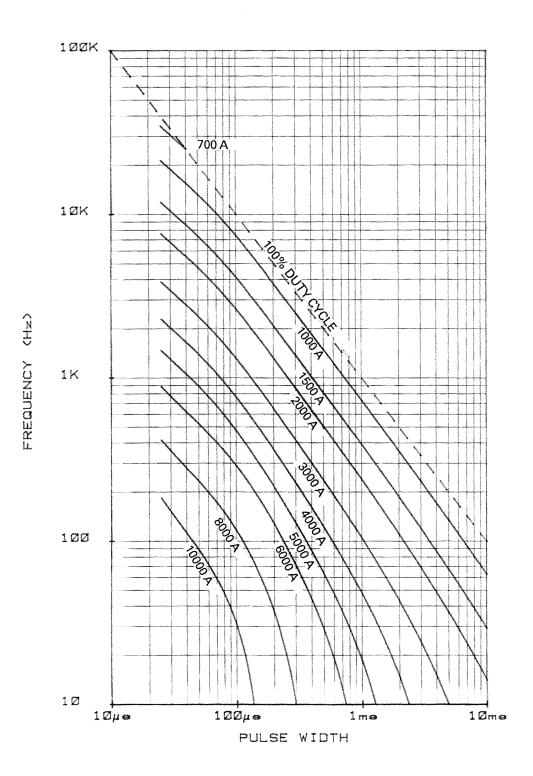
ТJ 125°C. 100A/µ⊖



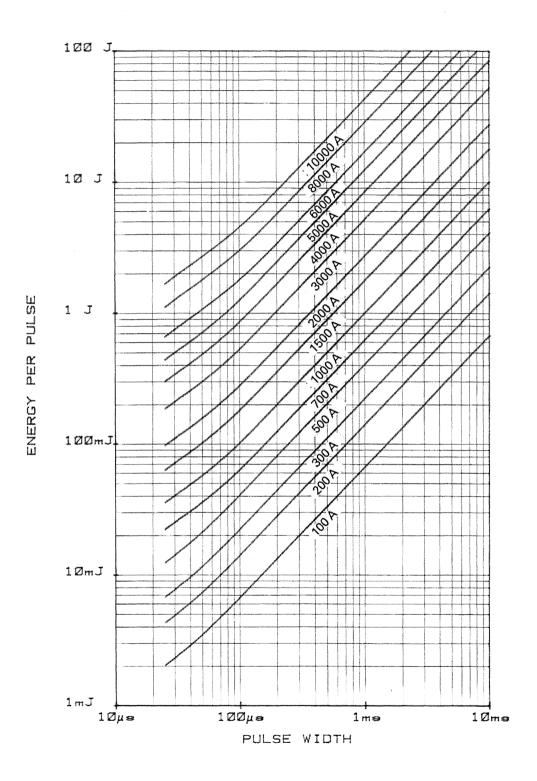
T SINK 85°C. SINE WAVE

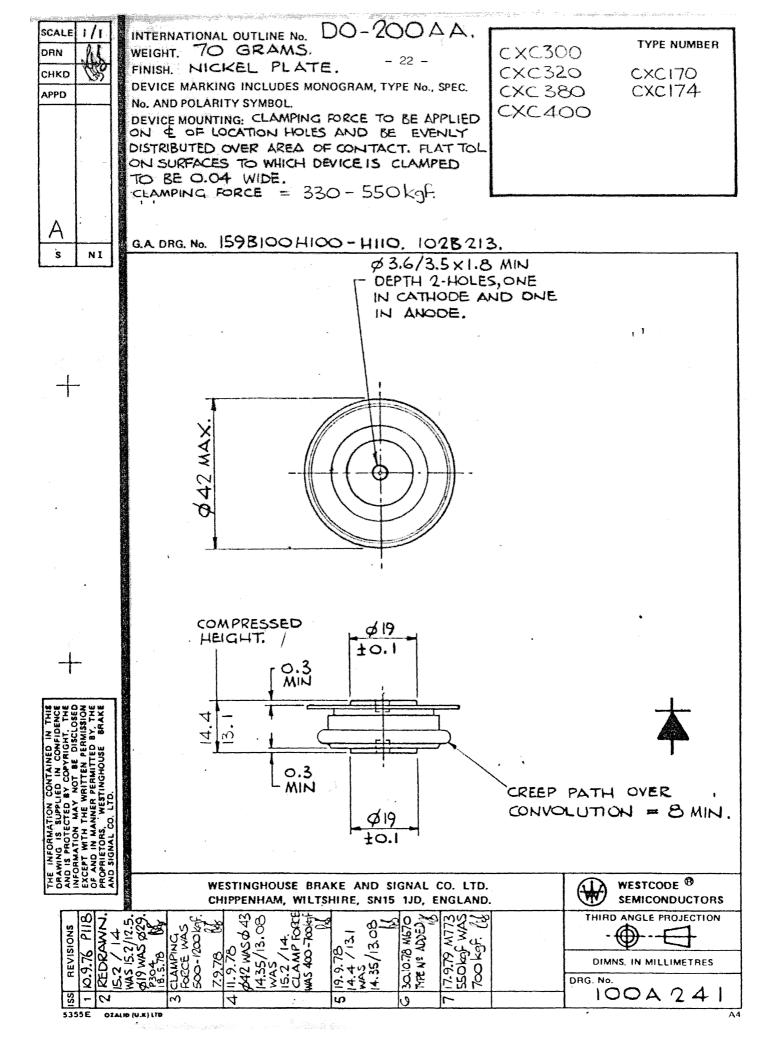


T SINK 55°C. SINE WAVE



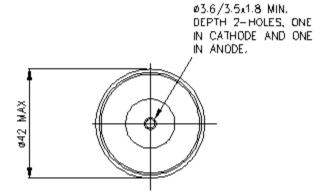
TJ 125°C. SINE WAVE

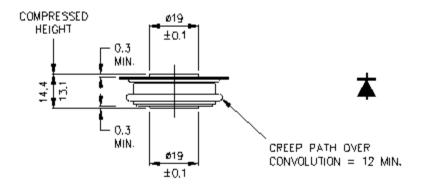




Drawing Number – W1 Outline Number – 100A241









Weight 70g